

Title: Liaison letter on IEEE 802.1CM TSN for Fronthaul
From: IEEE 802.1
For: Information
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Dear Colleagues,

IEEE 802.1 would like to thank 3GPP RAN3 for the information on the transport requirements for the high layer split provided in liaison letter R3-173354 (<http://www.ieee802.org/1/files/public/docs2017/liaison-3GPP-RAN3-173354-0917.zip>). We take it as input to a potential amendment to 802.1CM for the higher layer split (F1).

In continuation of our dialogue on transport for fronthaul, we would like to inform you that IEEE Std 802.1CM has been published, it is available at: <https://standards.ieee.org/findstds/standard/802.1CM-2018.html>.

We would like to maintain the dialogue between our organizations.

Respectfully submitted,
John Messenger
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